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Details

Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	20MHz
Connectivity	I ² C, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	36
Program Memory Size	14KB (8K x 14)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	512 x 8
Voltage - Supply (Vcc/Vdd)	2.3V ~ 5.5V
Data Converters	A/D 28x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	44-TQFP
Supplier Device Package	44-TQFP (10x10)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16f1517-i-pt

PIC16(L)F151X/152X

1.2 Pin Utilization

Five pins are needed for ICSP™ programming. The pins are listed in [Table 1-1](#) and [Table 1-2](#).

TABLE 1-1: PIN DESCRIPTIONS DURING PROGRAMMING – PIC16(L)F1526 AND PIC16(L)F1527

Pin Name	During Programming		
	Function	Pin Type	Pin Description
RB6	ICSPCLK	I	Clock Input – Schmitt Trigger Input
RB7	ICSPDAT	I/O	Data Input/Output – Schmitt Trigger Input
RG5/ $\overline{\text{MCLR}}$ /VPP	Program/Verify mode	P ⁽¹⁾	Program Mode Select/Programming Power Supply
VDD	VDD	P	Power Supply
VSS	VSS	P	Ground

Legend: I = Input, O = Output, P = Power

Note 1: The programming high voltage is internally generated. To activate the Program/Verify mode, high voltage needs to be applied to $\overline{\text{MCLR}}$ input. Since the $\overline{\text{MCLR}}$ is used for a level source, $\overline{\text{MCLR}}$ does not draw any significant current.

TABLE 1-2: PIN DESCRIPTIONS DURING PROGRAMMING – PIC16(L)F1512, PIC16(L)F1513, PIC16(L)F1516, PIC16(L)F1517, PIC16(L)F1518 and PIC16(L)F1519

Pin Name	During Programming		
	Function	Pin Type	Pin Description
RB6	ICSPCLK	I	Clock Input – Schmitt Trigger Input
RB7	ICSPDAT	I/O	Data Input/Output – Schmitt Trigger Input
RE3/ $\overline{\text{MCLR}}$ /VPP	Program/Verify mode	P ⁽¹⁾	Program Mode Select/Programming Power Supply
VDD	VDD	P	Power Supply
VSS	VSS	P	Ground

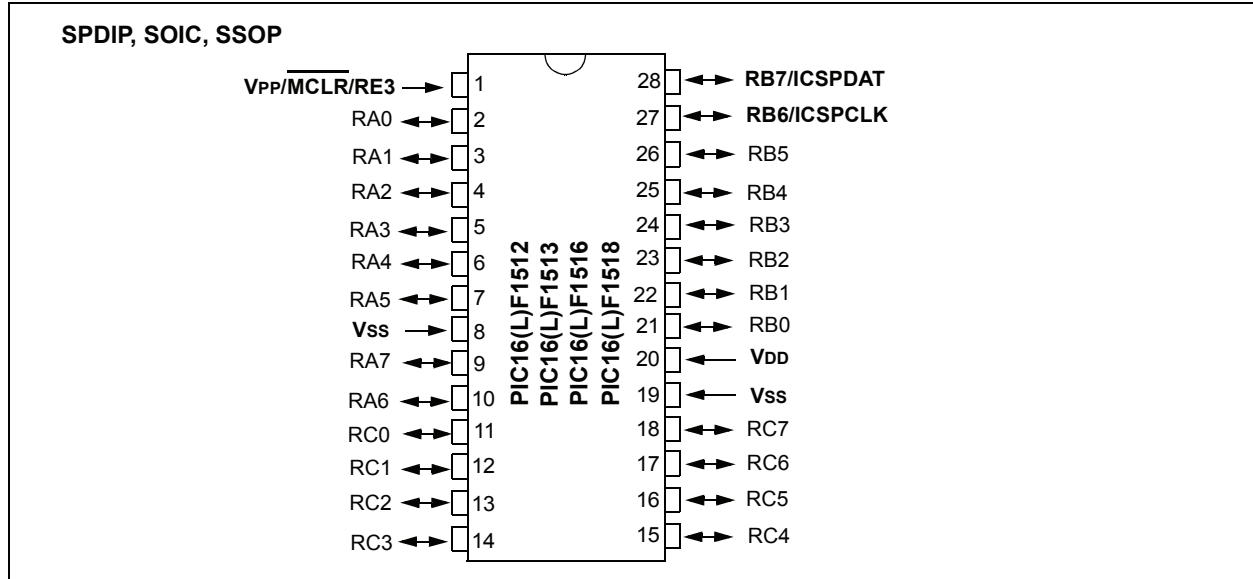
Legend: I = Input, O = Output, P = Power

Note 1: The programming high voltage is internally generated. To activate the Program/Verify mode, high voltage needs to be applied to $\overline{\text{MCLR}}$ input. Since the $\overline{\text{MCLR}}$ is used for a level source, $\overline{\text{MCLR}}$ does not draw any significant current.

2.0 DEVICE PINOUTS

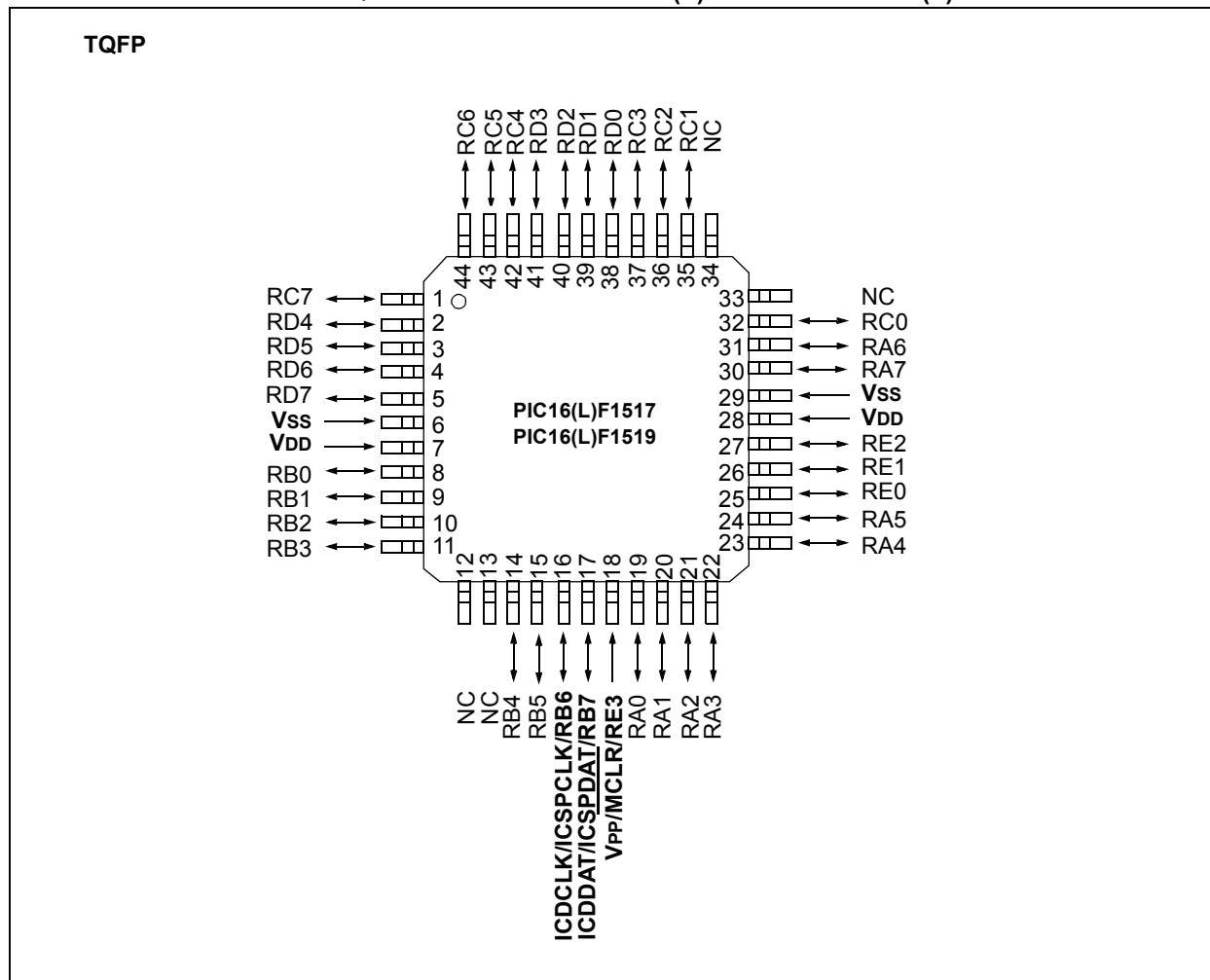
The pin diagrams for the PIC16(L)F151X/152X family are shown in Figure 2-1 through Figure 2-7. The pins that are required for programming are listed in Table 1-1 and shown in bold lettering in the pin diagrams.

FIGURE 2-1: 28-PIN SPDIP, SOIC, SSOP DIAGRAM FOR PIC16(L)F1512, PIC16(L)F1513, PIC16(L)F1516 AND PIC16(L)F1518



PIC16(L)F151X/152X

FIGURE 2-5: 44-PIN TQFP DIAGRAM FOR PIC16(L)F1517 AND PIC16(L)F1519

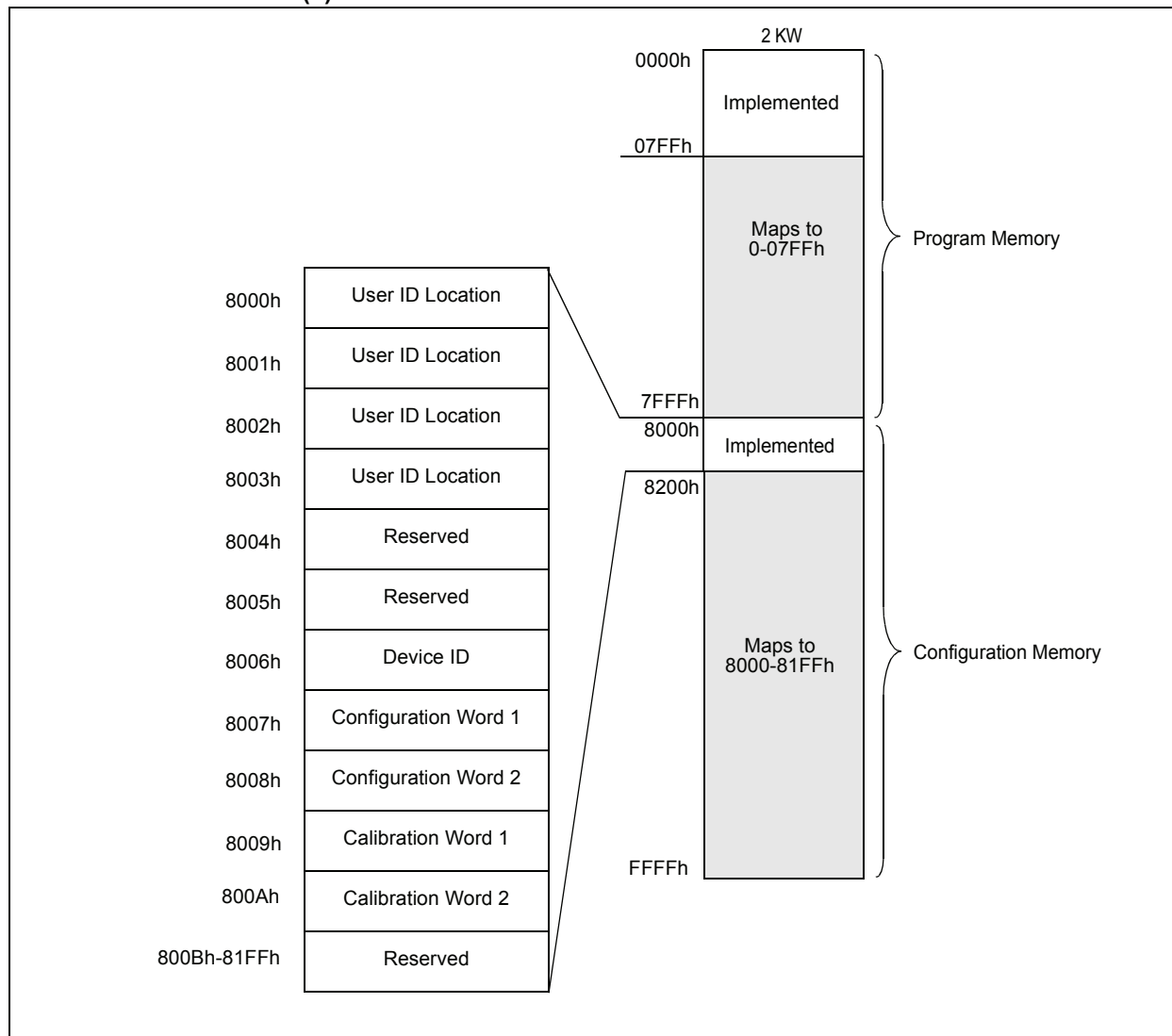


PIC16(L)F151X/152X

3.0 MEMORY MAP

The memory for the PIC16(L)F151X/152X devices is broken into two sections: program memory and configuration memory. Only the size of the program memory changes between devices, the configuration memory remains the same.

FIGURE 3-1: PIC16(L)F1512 PROGRAM MEMORY MAPPING



PIC16(L)F151X/152X

3.1 User ID Location

A user may store identification information (user ID) in four designated locations. The user ID locations are mapped to 8000h-8003h. Each location is 14 bits in length. Code protection has no effect on these memory locations. Each location may be read with code protection enabled or disabled.

Note: MPLAB® IDE only displays the 7 Least Significant bits (LSb) of each user ID location, the upper bits are not read. It is recommended that only the 7 LSbs be used if MPLAB IDE is the primary tool used to read these addresses.

3.2 Device ID

The device ID word is located at 8006h. This location is read-only and cannot be erased or modified.

REGISTER 3-1: DEVICE ID: DEVICE ID REGISTER⁽¹⁾

R	R	R	R	R	R
DEV<8:3>					
bit 13			bit 8		

R	R	R	R	R	R	R	R
DEV<2:0>				REV<4:0>			
bit 7				bit 0			

Legend:	P = Programmable bit	U = Unimplemented bit, read as '0'
R = Readable bit	W = Writable bit	'0' = Bit is cleared
-n = Value at POR	'1' = Bit is set	x = Bit is unknown

bit 13-5 **DEV<8:0>**: Device ID bits
These bits are used to identify the part number.

bit 4-0 **REV<4:0>**: Revision ID bits
These bits are used to identify the revision.

Note 1: This location cannot be written.

PIC16(L)F151X/152X

REGISTER 3-2: CONFIGURATION WORD 1

R/P-1	R/P-1	R/P-1	R/P-1	R/P-1	U-1
FCMEN	IESO	CLKOUTEN	BOREN<1:0>	—	
bit 13					bit 8

R/P-1	R/P-1	R/P-1	R/P-1	R/P-1	R/P-1	R/P-1	R/P-1
CP	MCLRE	PWRTÉ	WDTE<1:0>	FOSC<2:0>			
bit 7							bit 0

Legend:

R = Readable bit P = Programmable bit U = Unimplemented bit, read as '1'
 '0' = Bit is cleared '1' = Bit is set -n = Value when blank or after Bulk Erase

- bit 13 **FCMEN:** Fail-Safe Clock Monitor Enable bit
 1 = Fail-Safe Clock Monitor is enabled
 0 = Fail-Safe Clock Monitor is disabled
- bit 12 **IESO:** Internal External Switchover bit
 1 = Internal/External Switchover mode is enabled
 0 = Internal/External Switchover mode is disabled
- bit 11 **CLKOUTEN:** Clock Out Enable bit
 1 = CLKOUT function is disabled. I/O or oscillator function on CLKOUT pin.
 0 = CLKOUT function is enabled on CLKOUT pin
- bit 10-9 **BOREN<1:0>:** Brown-out Reset Enable bits⁽¹⁾
 11 = BOR enabled
 10 = BOR enabled during operation and disabled in Sleep
 01 = BOR controlled by SBOREN bit of the PCON register
 00 = BOR disabled
- bit 8 **Unimplemented:** Read as '1'
- bit 7 **CP:** Code Protection bit⁽²⁾
 1 = Program memory code protection is disabled
 0 = Program memory code protection is enabled
- bit 6 **MCLRE:** MCLR/VPP Pin Function Select bit
 If LVP bit = 1:
 This bit is ignored.
 If LVP bit = 0:
 1 = MCLR/VPP pin function is MCLR; Weak pull-up enabled.
 0 = MCLR/VPP pin function is digital input; MCLR internally disabled; Weak pull-up under control of WPUA register.
- bit 5 **PWRTÉ:** Power-up Timer Enable bit⁽¹⁾
 1 = PWRT disabled
 0 = PWRT enabled
- bit 4-3 **WDTE<1:0>:** Watchdog Timer Enable bit
 11 = WDT enabled
 10 = WDT enabled while running and disabled in Sleep
 01 = WDT controlled by the SWDTEN bit in the WDTCON register
 00 = WDT disabled
- bit 2-0 **FOSC<2:0>:** Oscillator Selection bits
 111 = ECH: External Clock, High-Power mode: on CLKIN pin
 110 = ECM: External Clock, Medium-Power mode: on CLKIN pin
 101 = ECL: External Clock, Low-Power mode: on CLKIN pin
 100 = INTOSC oscillator: I/O function on OSC1 pin
 011 = EXTRC oscillator: RC function on OSC1 pin
 010 = HS oscillator: High-speed crystal/resonator on OSC2 pin and OSC1 pin
 001 = XT oscillator: Crystal/resonator on OSC2 pin and OSC1 pin
 000 = LP oscillator: Low-power crystal on OSC2 pin and OSC1 pin

- Note** 1: Enabling Brown-out Reset does not automatically enable Power-up Timer.
 2: The entire program memory will be erased when the code protection is turned off.

REGISTER 3-3: CONFIGURATION WORD 2

R/P-1	R/P-1	R/P-1	R/P-1	R/P-1	U-1
LVP	DEBUG	LPBOR	BORV	STVREN	—
bit 13					bit 8

U-1	U-1	U-1	R/P-1	U-1	U-1	R/P-1	R/P-1
—	—	—	VCAPEN ⁽²⁾	—	—	WRT<1:0>	
bit 7							bit 0

Legend:

R = Readable bit

P = Programmable bit

U = Unimplemented bit, read as '1'

'0' = Bit is cleared

'1' = Bit is set

-n = Value when blank or after Bulk Erase

- bit 13 **LVP:** Low-Voltage Programming Enable bit⁽¹⁾
 1 = Low-voltage programming enabled
 0 = HV on MCLR/VPP must be used for programming
- bit 12 **DEBUG:** In-Circuit Debugger Mode bit
 1 = In-Circuit Debugger disabled, ICSPCLK and ICSPDAT are general purpose I/O pins
 0 = In-Circuit Debugger enabled, ICSPCLK and ICSPDAT are dedicated to the debugger
- bit 11 **LPBOR:** Low-Power BOR
 1 = Low-Power BOR is disabled
 0 = Low-Power BOR is enabled
- bit 10 **BORV:** Brown-out Reset Voltage Selection bit
 1 = Brown-out Reset voltage (VBOR), low trip point selected
 0 = Brown-out Reset voltage (VBOR), high trip point selected
- bit 9 **STVREN:** Stack Overflow/Underflow Reset Enable bit
 1 = Stack Overflow or Underflow will cause a Reset
 0 = Stack Overflow or Underflow will not cause a Reset
- bit 8-5 **Unimplemented:** Read as '1'
- bit 4 **VCAPEN:** Voltage Regulator Capacitor Enable bits⁽¹⁾
 0 = VCAP functionality is enabled on VCAP pin
 1 = All VCAP pin functions are disabled
- bit 3-2 **Unimplemented:** Read as '1'
- bit 1-0 **WRT<1:0>:** Flash Memory Self-Write Protection bits
2 kW Flash memory (PIC16(L)F1512):
 11 = Write protection off
 10 = 000h to 1FFh write-protected, 200h to 7FFh may be modified by PMCON control
 01 = 000h to FFFh write-protected, 400h to 7FFh may be modified by PMCON control
 00 = 000h to 7FFh write-protected, no addresses may be modified by PMCON control
4 kW Flash memory (PIC16(L)F1513):
 11 = Write protection off
 10 = 000h to 1FFh write-protected, 200h to FFFh may be modified by PMCON control
 01 = 000h to 7FFh write-protected, 800h to FFFh may be modified by PMCON control
 00 = 000h to FFFh write-protected, no addresses may be modified by PMCON control
8 kW Flash memory (PIC16F/LF1516/1517/1526):
 11 = Write protection off
 10 = 000h to 1FFh write-protected, 200h to 1FFFh may be modified by PMCON control
 01 = 000h to FFFh write-protected, 1000h to 1FFFh may be modified by PMCON control
 00 = 000h to 1FFFh write-protected, no addresses may be modified by PMCON control
16 kW Flash memory (PIC16F/LF1518/1519/1527):
 11 = Write protection off
 10 = 000h to 1FFh write-protected, 200h to 3FFFh may be modified by PMCON control
 01 = 000h to 1FFFh write-protected, 2000h to 3FFFh may be modified by PMCON control
 00 = 000h to 3FFFh write-protected, no addresses may be modified by PMCON control

Note 1: The LVP bit cannot be programmed to '0' when Programming mode is entered via LVP.

Note 2: Applies to PIC16F151X/152X devices only. On PIC16LF151X/152X, the VCAPEN bit is unimplemented.

PIC16(L)F151X/152X

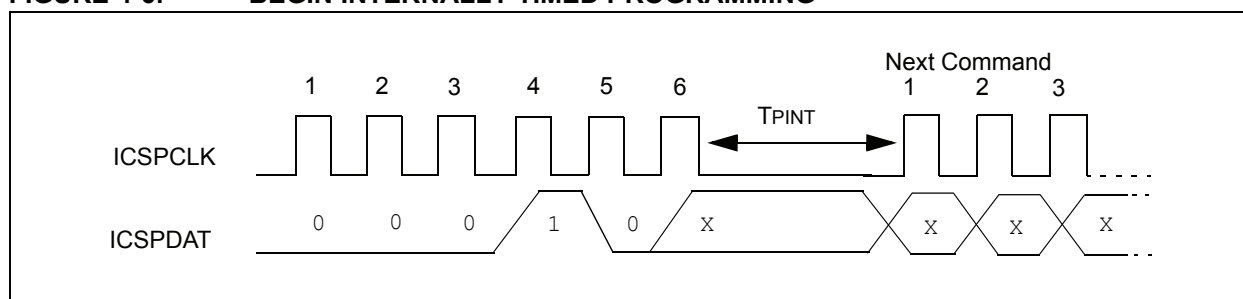
4.3.6 BEGIN INTERNALLY TIMED PROGRAMMING

A Load Configuration or Load Data for Program Memory command must be given before every Begin Programming command. Programming of the addressed memory will begin after this command is received. An internal timing mechanism executes the write. The user must allow for the program cycle time, T_{PINT} , for the programming to complete.

The End Externally Timed Programming command is not needed when the Begin Internally Timed Programming is used to start the programming.

The program memory address that is being programmed is not erased prior to being programmed.

FIGURE 4-6: BEGIN INTERNALLY TIMED PROGRAMMING

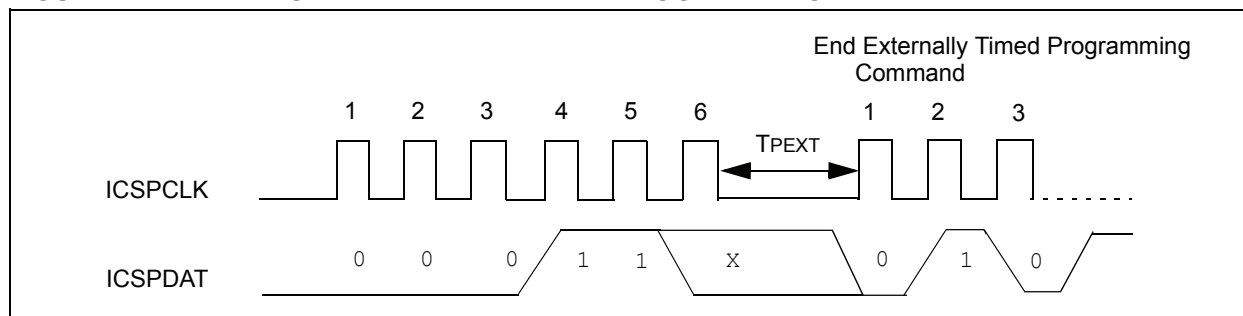


4.3.7 BEGIN EXTERNALLY TIMED PROGRAMMING

A Load Configuration or Load Data for Program Memory command must be given before every Begin Programming command. Programming of the addressed memory will begin after this command is received. To complete the programming the End Externally Timed Programming command must be sent in the specified time window defined by T_{PEXT} (see [Figure 4-7](#)).

Externally timed writes are not supported for Configuration and Calibration bits. Any externally timed write to the Configuration or Calibration Word will have no effect on the targeted word.

FIGURE 4-7: BEGIN EXTERNALLY TIMED PROGRAMMING



PIC16(L)F151X/152X

4.3.10 ROW ERASE PROGRAM MEMORY

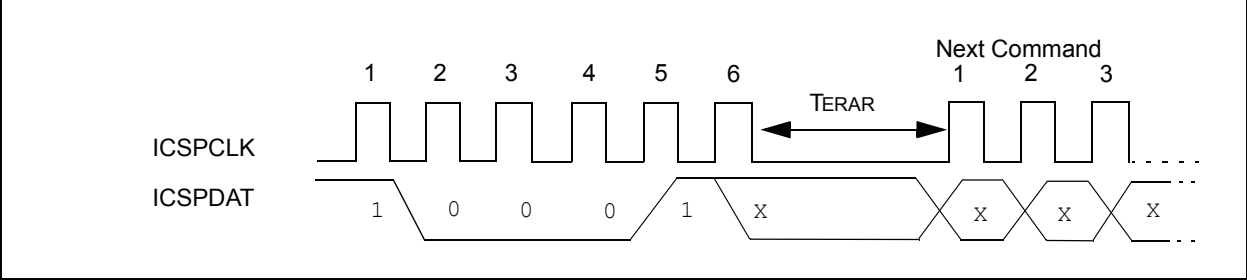
The Row Erase Program Memory command will erase an individual row. Refer to [Table 4-2](#) for row sizes of specific devices and the PC bits used to address them. If the program memory is code-protected the Row Erase Program Memory command will be ignored. When the address is 8000h-8008h the Row Erase Program Memory command will only erase the user ID locations regardless of the setting of the \overline{CP} Configuration bit.

After receiving the Row Erase Program Memory command the erase will not complete until the time interval, T_{ERAR} , has expired.

TABLE 4-2: PROGRAMMING ROW SIZE AND LATCHES

Devices	PC	Row Size	Number of Latches
PIC16(L)F151X/152X	<15:5>	32	32

FIGURE 4-10: ROW ERASE PROGRAM MEMORY



5.0 PROGRAMMING ALGORITHMS

The devices use internal latches to temporarily store the 14-bit words used for programming. Refer to [Table 4-2](#) for specific latch information. The data latches allow the user to write the program words with a single Begin Externally Timed Programming or Begin Internally Timed Programming command. The Load Program Data or the Load Configuration command is used to load a single data latch. The data latch will hold the data until the Begin Externally Timed Programming or Begin Internally Timed Programming command is given.

The data latches are aligned with the LSbs of the address. The PC's address at the time the Begin Externally Timed Programming or Begin Internally Timed Programming command is given will determine which location(s) in memory are written. Writes cannot cross the physical boundary. For example, with the PIC16F1527, attempting to write from address 0002h-0009h will result in data being written to 0008h-000Fh.

If more than the maximum number of data latches are written without a Begin Externally Timed Programming or Begin Internally Timed Programming command, the data in the data latches will be overwritten. The following figures show the recommended flowcharts for programming.

PIC16(L)F151X/152X

FIGURE 5-5: CONFIGURATION MEMORY PROGRAM FLOWCHART

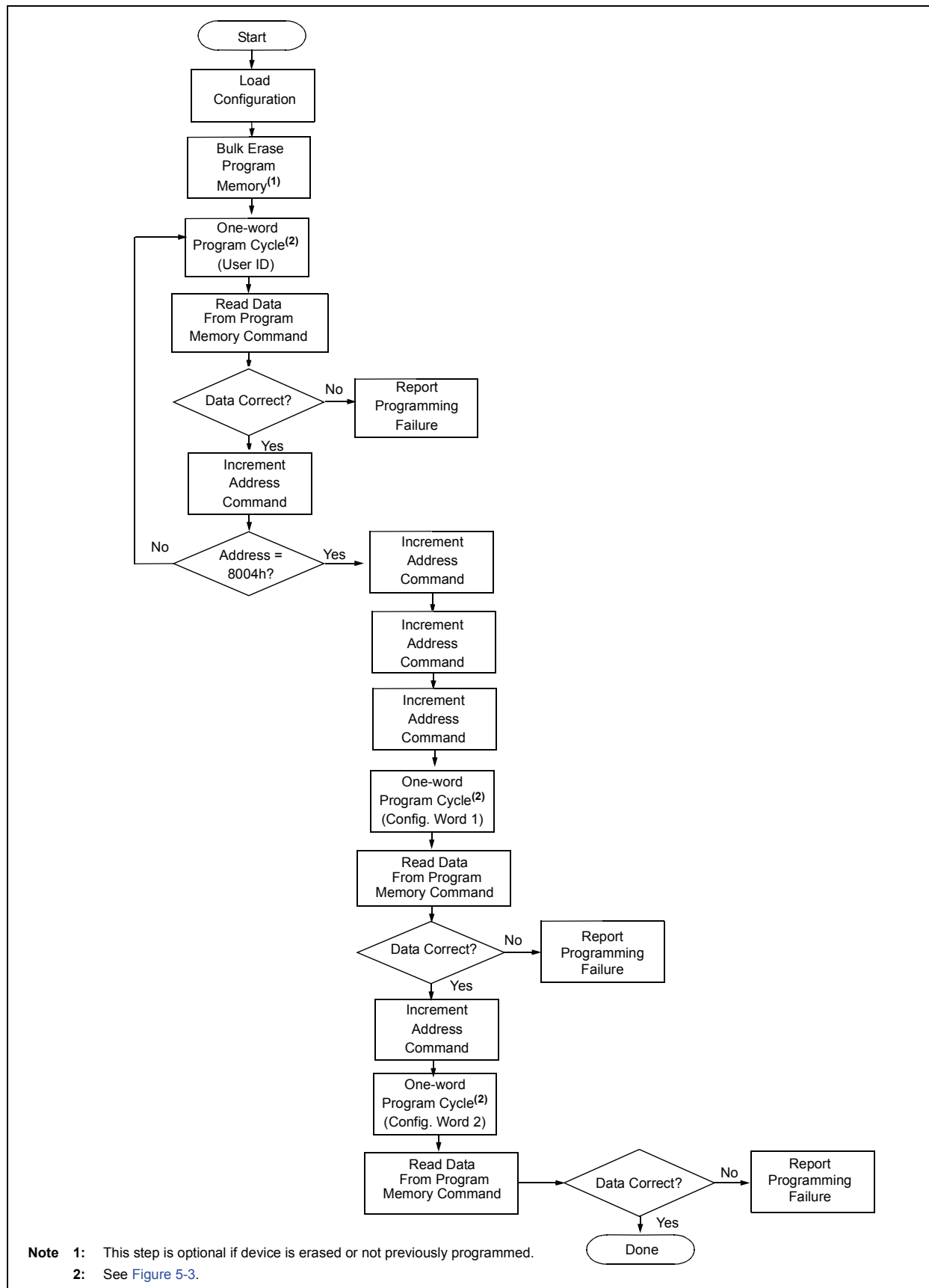
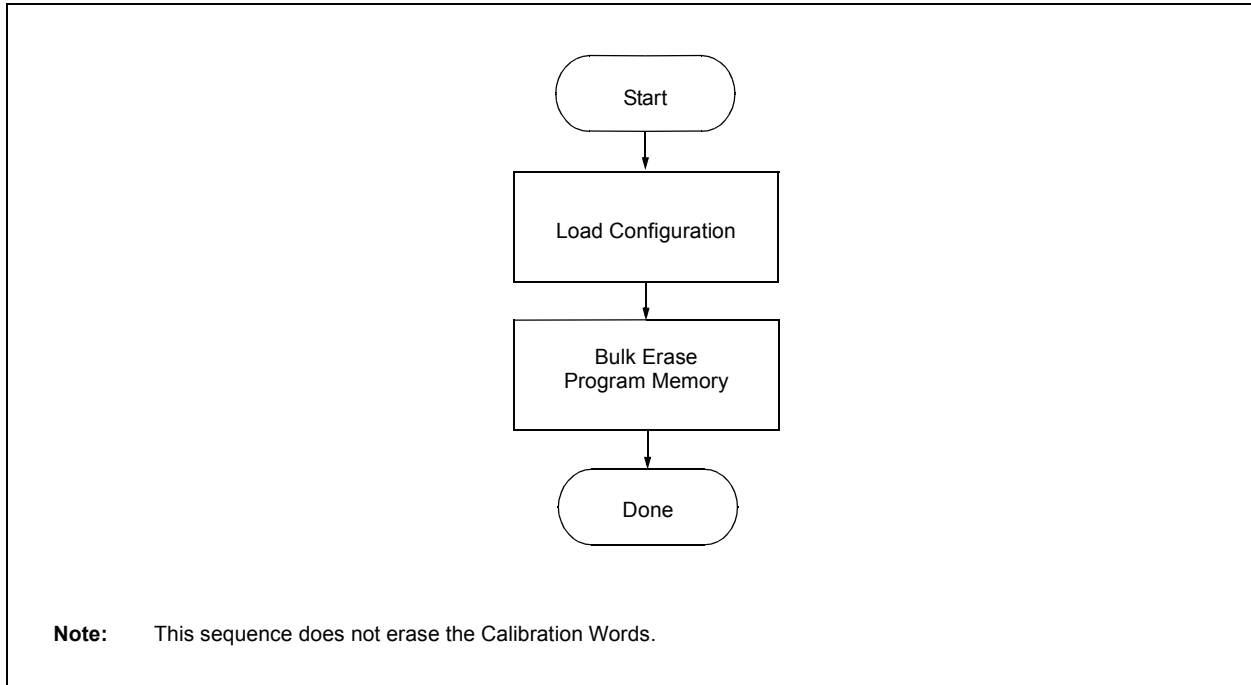


FIGURE 5-6: ERASE FLOWCHART



PIC16(L)F151X/152X

6.0 CODE PROTECTION

Code protection is controlled using the $\overline{\text{CP}}$ bit in Configuration Word 1. When code protection is enabled, all program memory locations (0000h-7FFFh) read as all '0'. Further programming is disabled for the program memory (0000h-7FFFh).

The user ID locations and Configuration Words can be programmed and read out regardless of the code protection settings.

6.1 Program Memory

Code protection is enabled by programming the $\overline{\text{CP}}$ bit in Configuration Word 1 register to '0'.

The only way to disable code protection is to use the Bulk Erase Program Memory command.

7.0 HEX FILE USAGE

In the hex file there are two bytes per program word stored in the Intel® INHX32 hex format. Data is stored LSB first, MSB second. Because there are two bytes per word, the addresses in the hex file are 2x the address in program memory. (Example: Configuration Word 1 is stored at 8007h on the PIC16(L)F151X/152X. In the hex file this will be referenced as 1000Eh-1000Fh).

7.1 Configuration Word

To allow portability of code, it is strongly recommended that the programmer is able to read the Configuration Words and user ID locations from the hex file. If the Configuration Words information was not present in the hex file, a simple warning message may be issued. Similarly, while saving a hex file, Configuration Words and user ID information should be included.

7.2 Device ID and Revision

If a device ID is present in the hex file at 1000Ch-1000Dh (8006h on the part), the programmer should verify the device ID (excluding the revision) against the value read from the part. On a mismatch condition the programmer should generate a warning message.

7.3 Checksum Computation

The checksum is calculated by two different methods dependent on the setting of the \overline{CP} Configuration bit.

TABLE 7-1: CONFIGURATION WORD MASK VALUES

Device	Config. Word 1 Mask	Config. Word 2 Mask
PIC16F1512	3EFFh	3E13h
PIC16F1513	3EFFh	3E13h
PIC16F1516	3EFFh	3E13h
PIC16F1517	3EFFh	3E13h
PIC16F1518	3EFFh	3E13h
PIC16F1519	3EFFh	3E13h
PIC16LF1512	3EFFh	3E03h
PIC16LF1513	3EFFh	3E03h
PIC16LF1516	3EFFh	3E03h
PIC16LF1517	3EFFh	3E03h
PIC16LF1518	3EFFh	3E03h
PIC16LF1519	3EFFh	3E03h
PIC16F1526	3EFFh	3E13h
PIC16F1527	3EFFh	3E13h
PIC16LF1526	3EFFh	3E03h
PIC16LF1527	3EFFh	3E03h

7.3.1 PROGRAM CODE PROTECTION DISABLED

With the program code protection disabled, the checksum is computed by reading the contents of the PIC16(L)F151X/152X program memory locations and adding up the program memory data starting at address 0000h, up to the maximum user addressable location. Any Carry bit exceeding 16 bits are ignored. Additionally, the relevant bits of the Configuration Words are added to the checksum. All unimplemented Configuration bits are masked to '0'.

PIC16(L)F151X/152X

EXAMPLE 7-1: CHECKSUM COMPUTED WITH PROGRAM CODE PROTECTION DISABLED PIC16F1527, BLANK DEVICE

PIC16F1527	Sum of Memory addresses 0000h-3FFFh ⁽¹⁾	C000h
	Configuration Word 1 ⁽²⁾	3FFFh
	Configuration Word 1 mask ⁽³⁾	3EFFh
	Configuration Word 2 ⁽²⁾	3FFFh
	Configuration Word 2 mask ⁽³⁾	3E13h
	Checksum	= C000h + (3FFFh and 3EFFh) + (3FFFh and 3E13h)
		= C000h + 3EFFh + 3E13h
		= 3D12h

- Note 1:** Sum of memory addresses = (Total number of program memory address locations) x (3FFFh) = C000h, truncated to 16 bits.
- 2:** Configuration Word 1 and 2 = all bits are '1'; thus, code-protect is disabled.
- 3:** Configuration Word 1 and 2 Mask = all bits are set to '1', except for unimplemented bits that are '0'.

EXAMPLE 7-2: CHECKSUM COMPUTED WITH PROGRAM CODE PROTECTION DISABLED PIC16LF1527, 00AAh AT FIRST AND LAST ADDRESS

PIC16LF1527	Sum of Memory addresses 0000h-3FFFh ⁽¹⁾	4156h
	Configuration Word 1 ⁽²⁾	3FFFh
	Configuration Word 1 mask ⁽³⁾	3EFFh
	Configuration Word 2 ⁽²⁾	3FFFh
	Configuration Word 2 mask ⁽⁴⁾	3E03h
	Checksum	= 4156h + (3FFFh and 3EFFh) + (3FFFh and 3E03h)
		= 4156h + 3EFFh + 3E03h
		= BE58h

- Note 1:** Total number of Program memory address locations: 3FFFh + 1 = 4000h. Then, 4000h - 2 = 3FFEh. Thus, [(3FFEh x 3FFFh) + (2 x 00AAh)] = 4156h, truncated to 16 bits.
- 2:** Configuration Word 1 and 2 = all bits are '1'; thus, code-protect is disabled.
- 3:** Configuration Word 1 Mask = all Configuration Word bits are set to '1', except for unimplemented bits that are '0'.
- 4:** On the PIC16LF1527 device, the $\overline{\text{VCAPEN}}$ bit is not implemented in Configuration Word 2; Thus, all unimplemented bits are '0'.

7.3.2 PROGRAM CODE PROTECTION ENABLED

With the program code protection enabled, the checksum is computed in the following manner: The Least Significant nibble of each user ID is used to create a 16-bit value. The masked value of user ID location 8000h is the Most Significant nibble. This sum of user IDs is summed with the Configuration Words (all unimplemented Configuration bits are masked to '0').

EXAMPLE 7-3: CHECKSUM COMPUTED WITH PROGRAM CODE PROTECTION ENABLED PIC16F1527, BLANK DEVICE

PIC16F1527	Configuration Word 1 ⁽²⁾	3F7Fh
	Configuration Word 1 mask ⁽³⁾	3EFFh
	Configuration Word 2 ⁽²⁾	3FFFh
	Configuration Word 2 mask ⁽³⁾	3E13h
	User ID (8000h) ⁽¹⁾	0006h
	User ID (8001h) ⁽¹⁾	0007h
	User ID (8002h) ⁽¹⁾	0001h
	User ID (8003h) ⁽¹⁾	0002h
	Sum of User IDs ⁽⁴⁾	$= (0006h \text{ and } 000Fh) \ll 12 + (0007h \text{ and } 000Fh) \ll 8 +$ $(0001h \text{ and } 000Fh) \ll 4 + (0002h \text{ and } 000Fh)$ $= 6000h + 0700h + 0010h + 0002h$ $= 6712h$
	Checksum	$= (3F7Fh \text{ and } 3EFFh) + (3FFFh \text{ and } 3E13h) + \text{Sum of User IDs}$ $= 3E7Fh + 3713h + 6712h$ $= DCA4h$

Note 1: User ID values in this example are random values.

2: Configuration Word 1 and 2 = all bits are '1' except the code-protect enable bit.

3: Configuration Word 1 and 2 Mask = all Configuration Word bits are set to '1', except for unimplemented bits which read '0'.

4: << = shift left, thus the LSb of the first user ID value is the MSb of the sum of user IDs and so on, until the LSb of the last user ID value becomes the LSb of the sum of user IDs.

8.0 ELECTRICAL SPECIFICATIONS

Refer to device specific data sheet for absolute maximum ratings.

TABLE 8-1: AC/DC CHARACTERISTICS TIMING REQUIREMENTS FOR PROGRAM/VERIFY MODE

AC/DC CHARACTERISTICS			Standard Operating Conditions Production tested at 25°C				
Sym.	Characteristics		Min.	Typ.	Max.	Units	Conditions/Comments
Supply Voltages and Currents							
VDD	Supply Voltage (VDDMIN, VDDMAX)	PIC16F151X PIC16F152X	2.3	—	5.5	V	
		PIC16LF151X PIC16LF152X	1.8	—	3.6	V	
VPEW	Read/Write and Row Erase operations		VDDMIN	—	VDDMAX	V	
VPBE	Bulk Erase operations		2.7	—	VDDMAX	V	
IDDI	Current on VDD, Idle		—	—	1.0	mA	
IDDP	Current on VDD, Programming		—	—	3.0	mA	
IPP	VPP						
	Current on MCLR/VPP		—	—	600	μA	
VIHH	High voltage on MCLR/VPP for Program/Verify mode entry		8.0	—	9.0	V	
TVHHR	MCLR rise time (VIL to VIH) for Program/Verify mode entry		—	—	1.0	μs	
	I/O pins						
VIH	(ICSPCLK, ICSPDAT, MCLR/VPP) input high level		0.8 VDD	—	—	V	
VIL	(ICSPCLK, ICSPDAT, MCLR/VPP) input low level		—	—	0.2 VDD	V	
VOH	ICSPDAT output high level		VDD-0.7 VDD-0.7 VDD-0.7	—	—	V	IOH = 3.5 mA, VDD = 5V IOH = 3 mA, VDD = 3.3V IOH = 2 mA, VDD = 1.8V
VOL	ICSPDAT output low level		—	—	VSS+0.6 VSS+0.6 VSS+0.6	V	IOH = 8 mA, VDD = 5V IOH = 6 mA, VDD = 3.3V IOH = 3 mA, VDD = 1.8V
Programming Mode Entry and Exit							
TENTS	Programing mode entry setup time: ICSPCLK, ICSPDAT setup time before VDD or MCLR↑		100	—	—	ns	
TENTH	Programing mode entry hold time: ICSPCLK, ICSPDAT hold time after VDD or MCLR↑		250	—	—	μs	
Serial Program/Verify							
TCKL	Clock Low Pulse Width		100	—	—	ns	
TCKH	Clock High Pulse Width		100	—	—	ns	
TDS	Data in setup time before clock↓		100	—	—	ns	
TDH	Data in hold time after clock↓		100	—	—	ns	
TCO	Clock↑ to data out valid (during a Read Data command)		0	—	80	ns	
TLZD	Clock↓ to data low-impedance (during a Read Data command)		0	—	80	ns	
THZD	Clock↓ to data high-impedance (during a Read Data command)		0	—	80	ns	
TDLY	Data input not driven to next clock input (delay required between command/data or command/command)		1.0	—	—	μs	
TERAB	Bulk Erase cycle time		—	—	5	ms	
TERAR	Row Erase cycle time		—	—	2.5	ms	

Note 1: Externally timed writes are not supported for Configuration and Calibration bits.

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TABLE 8-1: AC/DC CHARACTERISTICS TIMING REQUIREMENTS FOR PROGRAM/VERIFY

AC/DC CHARACTERISTICS		Standard Operating Conditions Production tested at 25°C				
Sym.	Characteristics	Min.	Typ.	Max.	Units	Conditions/Comments
TPINT	Internally timed programming operation time	—	—	2.5 5	ms ms	Program memory Configuration Words
TPEXT	Externally timed programming pulse	1.0	—	2.1	ms	Note 1
TDIS	Time delay from program to compare (HV discharge time)	300	—	—	μs	
TEXT	Time delay when exiting Program/Verify mode	1	—	—	μs	

Note 1: Externally timed writes are not supported for Configuration and Calibration bits.

8.1 AC Timing Diagrams

FIGURE 8-1: PROGRAMMING MODE ENTRY – VDD FIRST

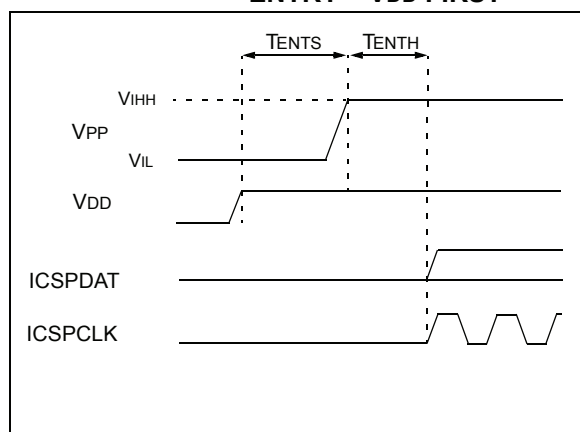


FIGURE 8-2: PROGRAMMING MODE ENTRY – VPP FIRST

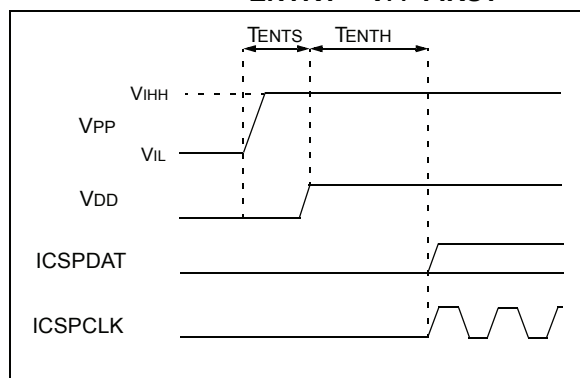


FIGURE 8-3: PROGRAMMING MODE EXIT – VPP LAST

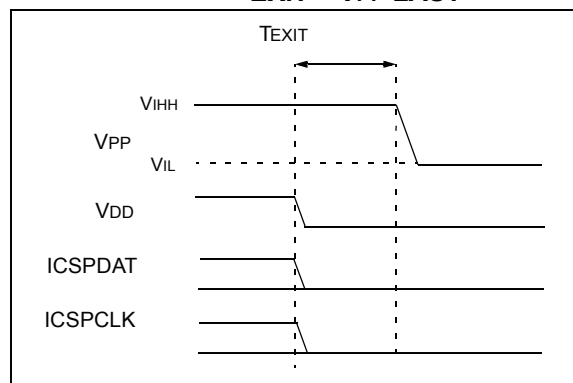
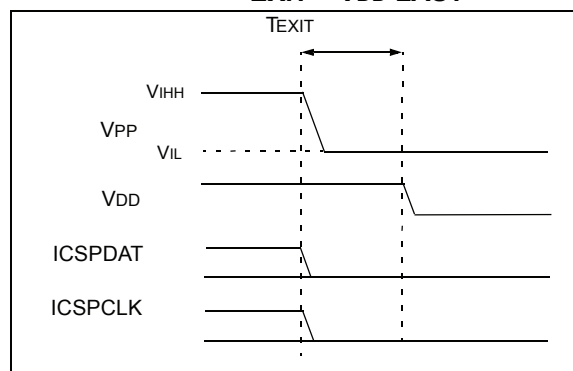


FIGURE 8-4: PROGRAMMING MODE EXIT – VDD LAST



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